



## Customer Information Notification

202105042I : Tray Supplier Change for BGA 12x12x1.2 Package from Peak to UBoT in ATKH

**Note:** This notice is NXP Company Proprietary.

**Issue Date:** Jun 17, 2021 **Effective date:** Jun 18, 2021

Dear Gordon Love,



Here is your personalized notification about a NXP general announcement.

For detailed information we invite you to [view this notification online](#)

### Management summary

For products in BGA 12x12x1.2 packaged in ATKH, NXP will change the tray supplier from Peak to UBoT.

### Change Category

- |  |   |   |   |   |
|--|---|---|---|---|
| <input type="checkbox"/> Wafer Fab Process   | <input type="checkbox"/> Assembly Process   | <input type="checkbox"/> Product Marking                      | <input type="checkbox"/> Test Process   | <input type="checkbox"/> Design                         |
| <input type="checkbox"/> Wafer Fab Materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification             | <input type="checkbox"/> Test Equipment | <input type="checkbox"/> Errata                         |
| <input type="checkbox"/> Wafer Fab Location  | <input type="checkbox"/> Assembly Location  | <input checked="" type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Location  | <input type="checkbox"/> Electrical spec./Test coverage |
| <input type="checkbox"/> Firmware            | <input type="checkbox"/> Other              |   |   |   |

## PCN Overview

### Description

For products in BGA 12x12x1.2 packaged in ATKH, NXP will change the tray supplier from Peak to UBoT.

Due to the differences in seating height, the two trays are not stackable. Customers should not mix or stack the two different trays .

Please refer to attachment for the detailed change.

### Reason

To standardize the trays.

### Identification of Affected Products

Product identification does not change

The tray manufacturer name is molded into the tray.

### Anticipated Impact on Form, Fit, Function, Reliability or Quality

No Impact on form, fit, function, reliability or quality except trays from different suppliers cannot be stacked.

### Disposition of Old Products

Existing inventory will be shipped until depleted

## Additional information

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Additional documents: [view online](#)

## Contact and Support

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For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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NXP Quality Management Team.

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